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January 2015

## FDMC86570LET60

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 60 V, 87 A, 4.3 m $\Omega$

#### Features

- Extended T<sub>J</sub> rating to 175°C
- Shielded Gate MOSFET Technology
- Max r<sub>DS(on)</sub> = 4.3 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 18 A
- Max  $r_{DS(on)}$  = 6.5 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 15 A
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free
- RoHS Compliant

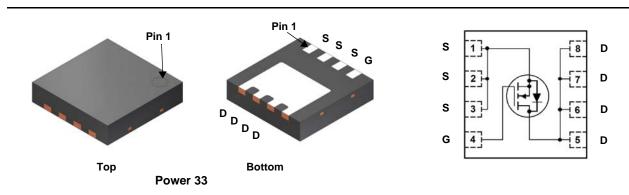


## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

#### Application

DC-DC Conversion



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter				Ratings	Units
V <sub>DS</sub>	Drain to Source	/oltage			60	V
V <sub>GS</sub>	Gate to Source V	/oltage			±20	V
ID	Drain Current	-Continuous	T <sub>C</sub> = 25 °C	(Note 5)	87	
		-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	62	^
		-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	18	Α
		-Pulsed		(Note 4)	436	
E <sub>AS</sub>	Single Pulse Ava	lanche Energy		(Note 3)	253	mJ
P <sub>D</sub>	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			65	w	
	Power Dissipatio	n	T <sub>A</sub> = 25 °C	(Note 1a)	2.8	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range				-55 to +175	°C

#### **Thermal Characteristics**

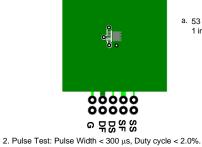
$R_{\thetaJC}$	Thermal Resistance, Junction to Case	(Note 1)	2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/VV

### Package Marking and Ordering Information

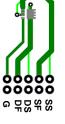
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86570LT	FDMC86570LET60	Power33	13 "	12 mm	3000 units

FDMC86570LET60	
N-Channel	
Shielded (	
<sup>-</sup> DMC86570LET60 N-Channel Shielded Gate PowerTrench <sup>0</sup>	
<sup>®</sup> MOSFET	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		30		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.8	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 18 A		3.1	4.3	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		4.7	6.5	
		$V_{GS}$ = 10 V, I <sub>D</sub> = 18 A, T <sub>J</sub> = 125 °C		5.0	6.9	
9fs	Forward Transconductance	$V_{DD} = 5 V, I_D = 18 A$		75		S
•	Characteristics					
C <sub>iss</sub>	Input Capacitance	V 20.V.V. 0.V.		4790		pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz		821		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			19		pF
Rg	Gate Resistance		0.1	0.9	2.7	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			19	34	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 18 A,		6.2	12	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		38	61	ns
t <sub>f</sub>	Fall Time			3.9	10	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		63	88	nC
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 30 \text{ V},$		29	41	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 18 A		14		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			6.3		nC
Drain-Sou	urce Diode Characteristics					
Vap	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 18 A$ (Note 2)		0.8	1.3	V
V <sub>SD</sub>		$V_{GS} = 0 V, I_S = 1.9 A$ (Note 2)		0.7	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 18 A, di/dt = 100 A/μs		43	69	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$r_{\rm F} = 10.00,  {\rm d}_{\rm F}  {\rm d}_{\rm F}  {\rm d}_{\rm F} = 100.00  {\rm J}_{\rm F}  {\rm m}_{\rm F}$		26	42	nC



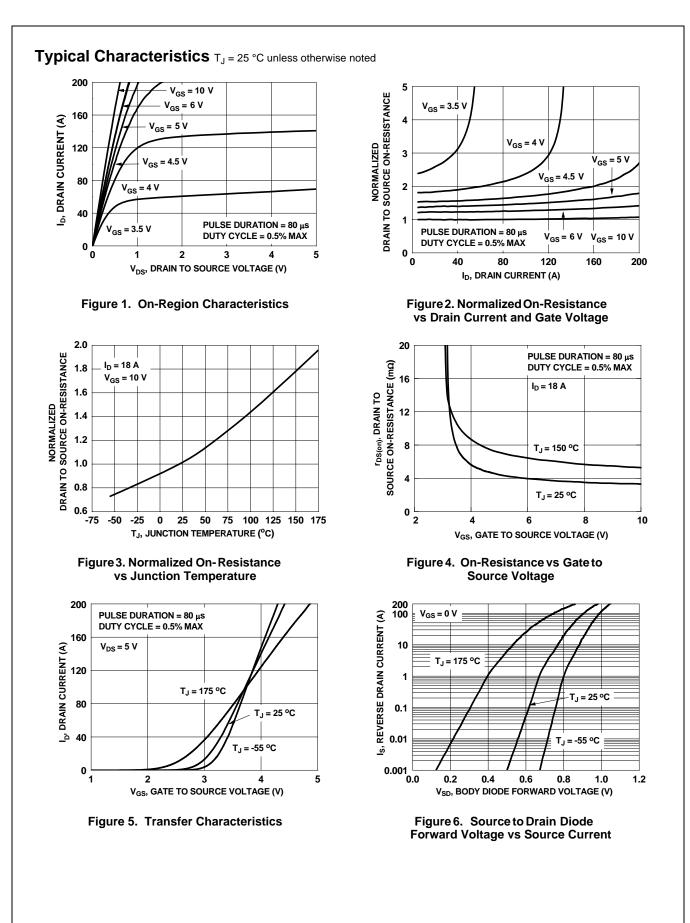
 a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

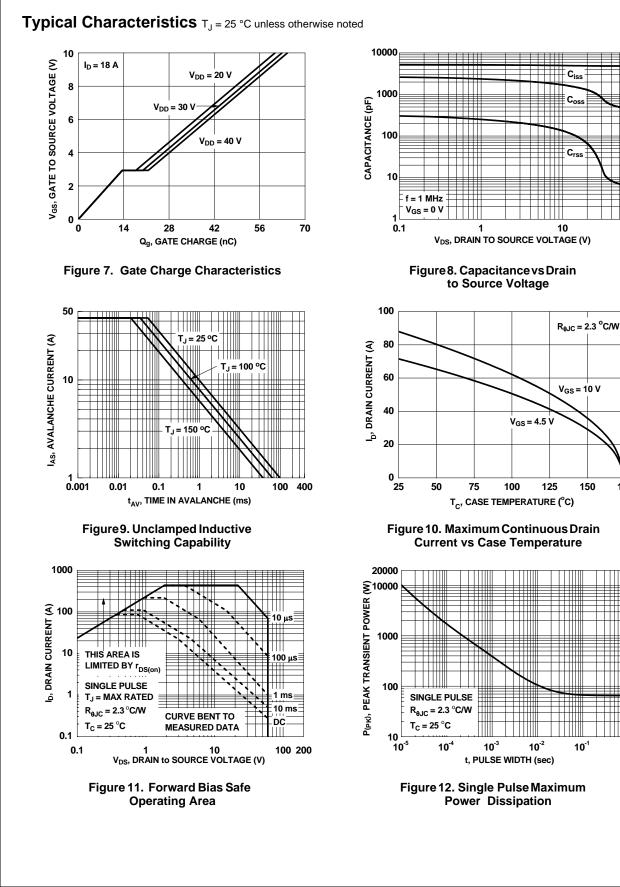


b. 125 °C/W when mounted on a minimum pad of 2 oz copper

3.  $E_{AS}$  of 253 mJ is based on starting  $T_J = 25$  °C, L = 3 mH,  $I_{AS} = 13$  A,  $V_{DD} = 60$  V,  $V_{GS} = 10$  V. 100% test at L = 0.1 mH,  $I_{AS} = 43$  A. 4. Pulsed Id please refer to Fig 11 SOA graph for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



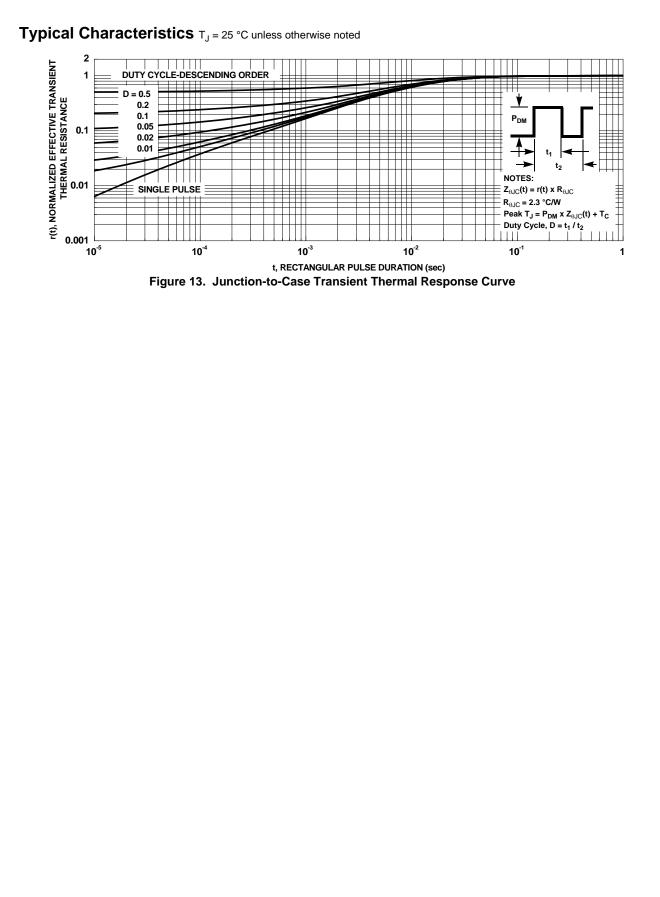


1

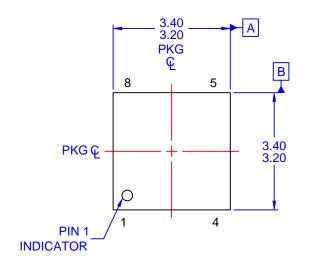
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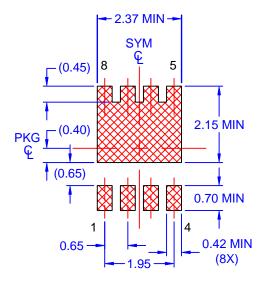
150

175

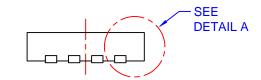


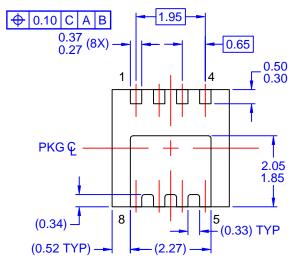
5

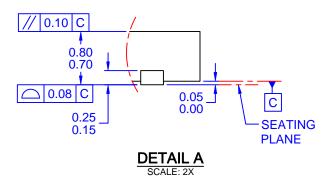












#### NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. BA, DATED OCTOBER 2002.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08HREV1

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